



US00D457434S

(12) **United States Design Patent**
Soh et al.

(10) **Patent No.:** **US D457,434 S**

(45) **Date of Patent:** **** May 21, 2002**

(54) **TRAY FOR SEMICONDUCTOR PACKAGING**

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(**) Term: **14 Years**

(57) **CLAIM**

(21) Appl. No.: **29/136,212**

The ornamental design for a tray for semiconductor packaging, as shown and described.

(22) Filed: **Jan. 26, 2001**

DESCRIPTION

(51) **LOC (7) Cl.** **09-07**

(52) **U.S. Cl.** **D9/456**

(58) **Field of Search** D9/434, 456; 206/832, 206/710-712

FIG. 1 is a top plan view of a tray for semiconductor packaging showing our new design; FIG. 2 is a bottom plan view thereof; FIG. 3 is a left side elevational view thereof; FIG. 4 is a right side elevational view thereof; FIG. 5 is a rear elevational view thereof; and, FIG. 6 is a front elevational view thereof.

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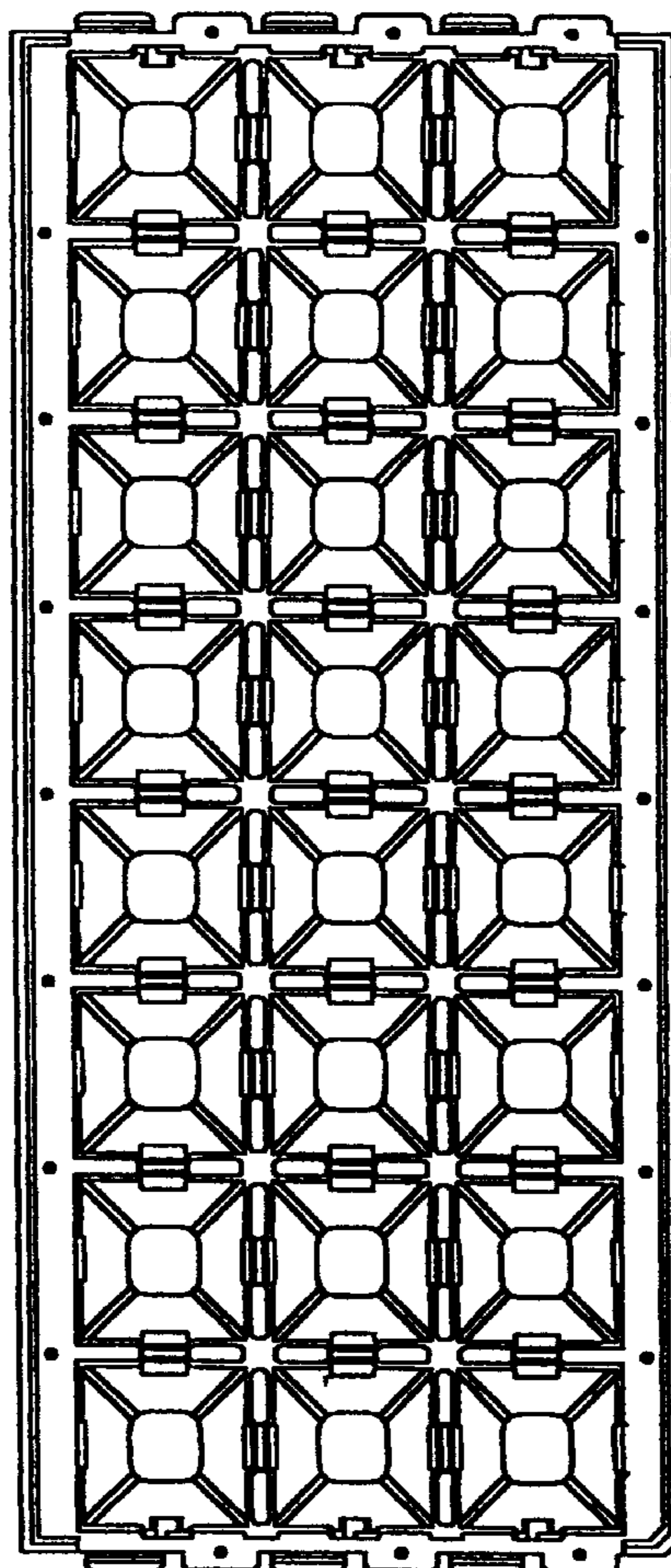
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1 Claim, 6 Drawing Sheets



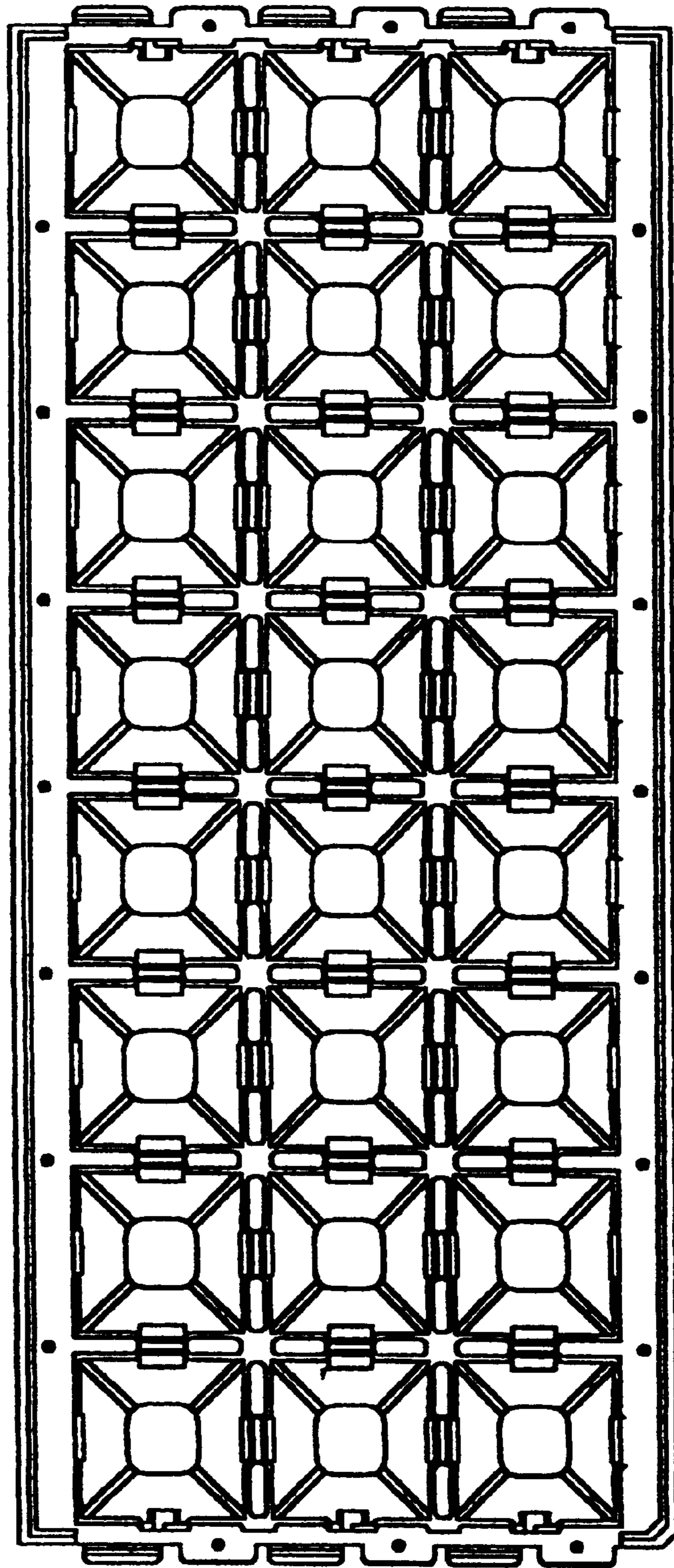


FIG. 1

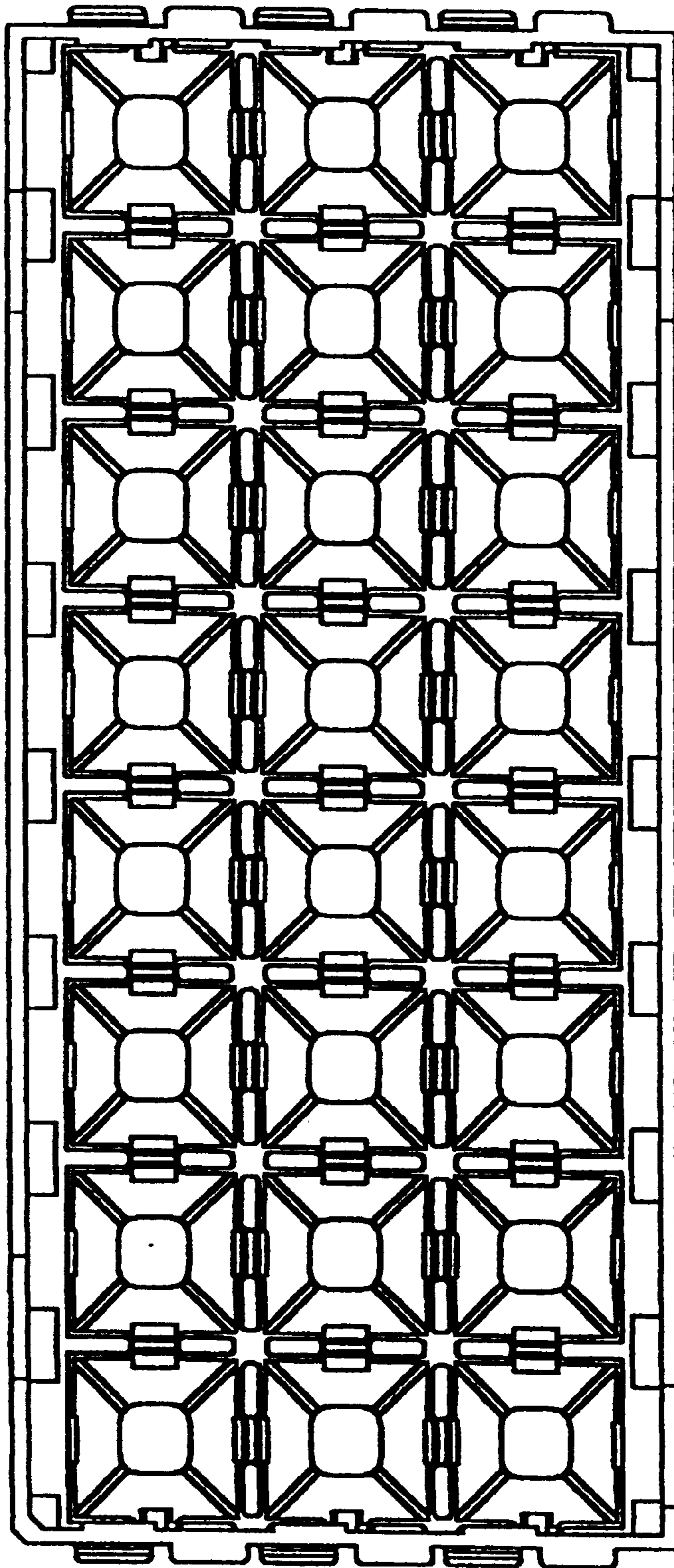


FIG. 2



FIG. 3



FIG. 4



FIG. 5

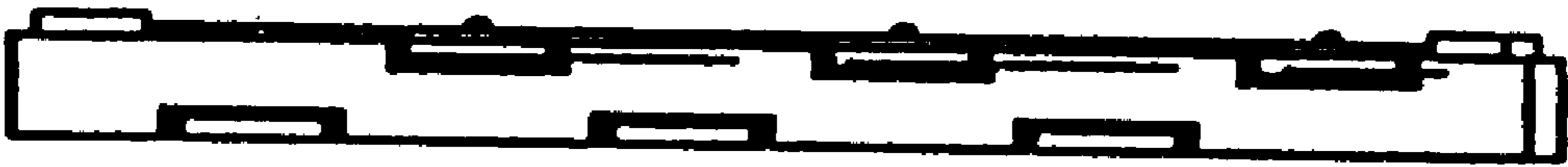


FIG. 6